

Aeluma to Present at SPIE Defense + Commercial Sensing Conference

April 25, 2024 in National Harbor, Maryland

GOLETA, CA / ACCESSWIRE / March 29, 2024 /Aeluma, Inc. (OTCQB:ALMU), a semiconductor company specializing in high performance, scalable technologies for mobile, automotive, communication, and defense & aerospace, announced today that its CEO will deliver a presentation at the upcoming SPIE Defense + Commercial Sensing 2024 in National Harbor, MD.

The conference invited Aeluma CEO Jonathan Klamkin, Ph.D., to deliver a presentation titled "Heterogeneous integration of quantum dot and nonlinear materials on 300mm silicon photonic wafers for communications, sensing, and quantum applications" at the conference on April 25, 2024 at 11:40 a.m. ET at the Gaylord National Resort And Convention Center.

<u>SPIE Defense + Commercial Sensing Exhibition</u> is considered "the most important event for learning about sensing technologies being rapidly acquired and deployed within the public, security, and government applications." To meet with Dr. Klamkin at the conference, attendees are encouraged to contact the company at info@aeluma.com.

The Office of the Secretary of Defense recently granted Aelumaa funding award to develop foundry-scale, CMOS-compatible quantum materials, and the conference presentation will highlight related technology.

About Aeluma, Inc.

Aeluma (www.aeluma.com) develops novel optoelectronics for sensing and communication applications. Aeluma has pioneered a technique to manufacture semiconductor chips using high-performance compound semiconductor materials on large-diameter substrates that are commonly used for mass-market microelectronics. The technology has the potential to enhance performance and scale manufacturing, both of which are critical for emerging applications. Aeluma is developing a streamlined business model from its headquarters in Santa Barbara, California that has a state-of-the-art manufacturing cleanroom. Its transformative semiconductor chip technology may impact a variety of markets including automotive LiDAR (light detection and ranging), mobile, defense & aerospace, AR/VR, AI, quantum, and communication. Aeluma differentiates itself with unique semiconductor manufacturing capability, proprietary technology, the ability to perform rapid prototyping, and a broad set of product offerings.

Forward-Looking Statements

All statements in this press release that are not historical are forward-looking statements, including, among other things, statements relating to the Company's expectations regarding its market position and market opportunity, expectations and plans as to its product

development, manufacturing and sales, and relations with its partners and investors. These statements are not historical facts but rather are based on the Company's current expectations, estimates, and projections regarding its business, operations and other similar or related factors. Words such as "may," "will," "could," "would," "should," "anticipate," "predict," "potential," "continue," "expect," "intend," "plan," "project," "believe," "estimate," and other similar or related expressions are used to identify these forward-looking statements, although not all forward-looking statements contain these words. You should not place undue reliance on forward-looking statements because they involve known and unknown risks, uncertainties, and assumptions that are difficult or impossible to predict and, in some cases, beyond the Company's control. Actual results may differ materially from those in the forward-looking statements as a result of a number of factors, including those described in the Company's filings with the Securities and Exchange Commission. The Company undertakes no obligation to revise or update information in this release to reflect events or circumstances in the future, even if new information becomes available.

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